

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L5	2505	((copper cu) same (iron Fe) same (paste ink))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 18:29
L6	1535	5 and (ceramic glass)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 18:30
L7	772	6 and powder	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 18:30
L8	8	("4070518"   "4789411"   "5287620"   "5336444"   "5468445"   "5514326"   "6156237"   "6489014").PN. OR ("6855399").URPN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 18:36
L9	70	((iron adj III adj oxide) and "Fe.sub.2O.sub.3")	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/16 18:36
L10	18	((iron adj II adj oxide) and "Fe.sub.2O.sub.3")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 18:50
L11	1206	(copper adj paste) and (pcb pwb (printed circuit) ((circuit wiring) adj board))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 18:59

L12	555	11 and ceramic	US-PGPUB; USPAT;	OR	ON	2005/03/16 18:59
L16	11911	(copper adj powder)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 19:53
L17	973	16 and ((iron adj III adj oxide) (iron adj oxide) fe2o3 "Fe. <sub>2</sub> O. <sub>3</sub> ")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 20:19
L18	299	17 and paste	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 19:54
L19	6	17 and (conductive adj paste)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 19:55
L20	9	17 and (copper adj paste)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 19:55
L21	21	("4140817"   "4234367"   "4409261"   "4493789"   "4540604"   "4594181"   "4619836"   "4687597"   "4695403"   "4714570"   "4880684"   "4919643"   "4937016"   "5011725"   "5167869").PN. OR ("5336444").URPN. (252/512-514).CCLS.	US-PGPUB; USPAT; USOCR US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 20:12
L22	3255		US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/16 20:12



S7	1	1988-193904.NRAN. (conductor conductive) adj paste	DERWENT	OR	ON	2005/03/12 17:04
S8	20040		US-PGPUB; USPAT;	OR	ON	2005/03/12 17:06
S9	876	S8 and (copper adj powder)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 19:53
S10	400	S9 and ((iron adj III adj oxide) (iron oxide) fe2o3 "Fe.sub.2O.sub.3")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 18:50
S11	6	S9 and ((iron adj III adj oxide) (iron adj oxide) fe2o3 "Fe.sub.2O.sub.3")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 19:53
S12	2263	(174/256-259).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/12 17:15
S13	328	S12 and (copper and ceramic and paste)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/12 17:15
S14	8	("4070518"   "4789411"   "5287620"   "5336444"   "5468445"   "5514326"   "6156237"   "6489014").PN. OR ("6855399").URPN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB USOCR	OR	ON	2005/03/15 18:26

S15	2	("4540604").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/03/15 18:26
S16	21	("4140817"   "4234367"   "4409261"   "4493789"   "4540604"   "4594181"   "4619836"   "4687597"   "4695403"   "4714570"   "4880684"   "4919643"   "4937016"   "5011725"   "5167869").PN. OR ("533644").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/15 18:29
S17	1	1988-193904.NRAN.	DERWENT	OR	ON	2005/03/15 18:48
S18	94869	((iron adj III adj oxide) (iron adj oxide) fe2o3 "Fe.sub.20.sub.3")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 18:57
S19	973	S18 and (copper adj powder)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:24
S20	299	S19 and paste	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:24
S21	6	((iron adj III adj oxide) (iron adj oxide) fe2o3 "Fe.sub.20.sub.3") and ((conductive adj paste) and (copper adj powder))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 18:58
S22	299	((iron adj III adj oxide) (iron adj oxide) fe2o3 "Fe.sub.20.sub.3") and ( paste) and (copper adj powder)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 18:58

S23	0	S22 not S19	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 18:58
S24	203	S19 and ink	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 18:59
S25	253	S19 and (pcb pwb (printed circuit) ((circuit wiring) adj board))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/16 18:59
S26	46	S19 and (pcb pwb (printed adj circuit) ((circuit wiring) adj board))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:20
S27	20	S20 and (pcb pwb (printed adj circuit) ((circuit wiring) adj board))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:20
S28	4841	S18 and (copper same powder)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:20
S29	1056	S28 and paste	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:24

S30	497	S29 and ceramic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:24
S31	375042	"280" not S22	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:25
S32	3744605	"28" not S22	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:25
S33	366	S30 not S22	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/15 19:25